



PCT

WORLD INTELLECTUAL PROPERTY ORGANIZATION
International Bureau

INTERNATIONAL APPLICATION PUBLISHED UNDER THE PATENT COOPERATION TREATY (PCT)

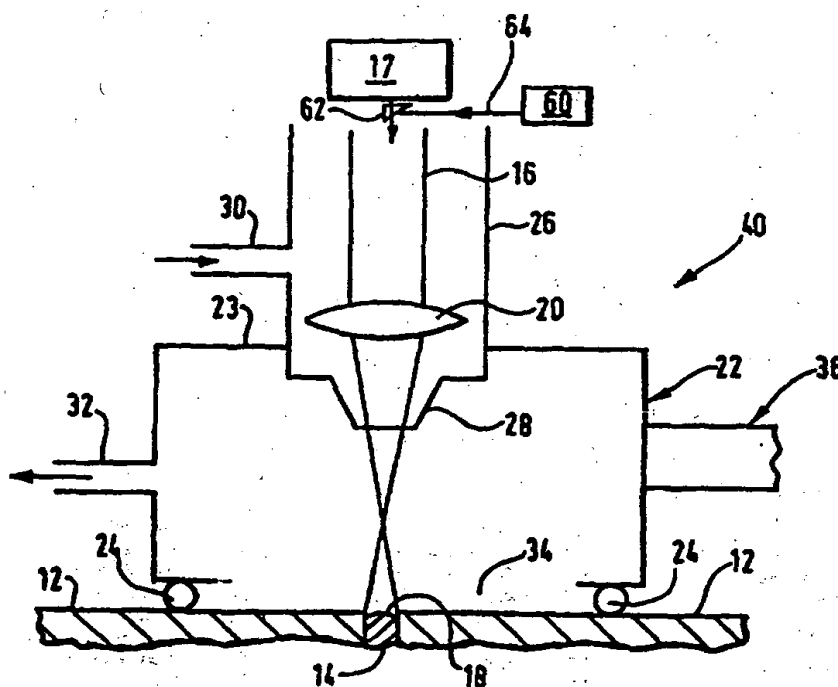
(51) International Patent Classification 6 : B28D 1/22, B23K 26/00, E04F 21/16		A1	(11) International Publication Number: WO 97/48536
			(43) International Publication Date: 24 December 1997 (24.12.97)
(21) International Application Number: PCT/GB97/01638		(81) Designated States: CA, CN, JP, KR, RU, UA, US, European patent (AT, BE, CH, DE, DK, ES, FI, FR, GB, GR, IE, IT, LU, MC, NL, PT, SE).	
(22) International Filing Date: 18 June 1997 (18.06.97)			
(30) Priority Data: 9612776.6 19 June 1996 (19.06.96) GB 9614600.6 11 July 1996 (11.07.96) GB		Published With international search report.	
(71) Applicant (for all designated States except US): BRITISH NUCLEAR FUELS PLC [GB/GB]; Risley, Warrington WA3 6AS (GB).			
(72) Inventors; and (75) Inventors/Applicants (for US only): SPENCER, Julian, Timothy [GB/GB]; British Nuclear Fuels plc, Research & Technology, Springfield Works, Salwick, Preston PR4 0XJ (GB). LI, Lin [GB/GB]; Manufacturing Division, Dept. of Mechanical Engineering, Umist, Manchester M60 1QD (GB). LAWRENCE, Jonathan [GB/GB]; Manufacturing Division, Dept. of Mechanical Engineering, Umist, Manchester M60 1QD (GB).			
(74) Agents: GODDARD, David, John; Harrison Goddard Foote, Vine House, 22 Hollins Lane, Marple Bridge, Stockport SK6 5BB (GB) et al.			

2

(54) Title: **GROUT OR MORTAR REMOVAL BY LASER**

(57) Abstract

The method comprises the steps of directing the beam of a portable laser device (40) onto grout (14) at a power level to cause removal of the grout; causing mutual relative movement between said laser beam and said grout; and, providing removal means (30, 32) for debris resulting from said grout removal. The laser beam (16) is transmitted to the grout (14) via optical fibre. The laser is selected from the group comprising: Nd-YAG laser, semi-conductor laser, and, diode pumped fibre laser, and may also include a low-power visible aiming laser. An area of grout being treated is surrounded by an enclosure (22) to prevent escape of laser light. The enclosure is transparent to optical light and opaque to laser light of the wavelength, e.g. 0.4 to 10.6 μm , in use. The laser beam spot (18) size being commensurate with the grout width. Debris removal means, possibly assisted with a gas jet (42), comprises suction removal (44) at a position adjacent the grout laser treatment area. The method may include the step of applying additional water to the grout.



FOR THE PURPOSES OF INFORMATION ONLY

Codes used to identify States party to the PCT on the front pages of pamphlets publishing international applications under the PCT.

AL	Albania	ES	Spain	LS	Lesotho	SI	Slovenia
AM	Armenia	FI	Finland	LT	Lithuania	SK	Slovakia
AT	Austria	FR	France	LU	Luxembourg	SN	Senegal
AU	Australia	GA	Gabon	LV	Latvia	SZ	Swaziland
AZ	Azerbaijan	GB	United Kingdom	MC	Monaco	TD	Chad
BA	Bosnia and Herzegovina	GE	Georgia	MD	Republic of Moldova	TG	Togo
BB	Barbados	GH	Ghana	MG	Madagascar	TJ	Tajikistan
BE	Belgium	GN	Guinea	MK	The former Yugoslav Republic of Macedonia	TM	Turkmenistan
BF	Burkina Faso	GR	Greece	ML	Mali	TR	Turkey
BG	Bulgaria	HU	Hungary	MN	Mongolia	TT	Trinidad and Tobago
BJ	Benin	IE	Ireland	MR	Mauritania	UA	Ukraine
BR	Brazil	IL	Israel	MW	Malawi	UG	Uganda
BY	Belarus	IS	Iceland	MX	Mexico	US	United States of America
CA	Canada	IT	Italy	NE	Niger	UZ	Uzbekistan
CF	Central African Republic	JP	Japan	NL	Netherlands	VN	Viet Nam
CG	Congo	KE	Kenya	NO	Norway	YU	Yugoslavia
CH	Switzerland	KG	Kyrgyzstan	NZ	New Zealand	ZW	Zimbabwe
CI	Côte d'Ivoire	KP	Democratic People's Republic of Korea	PL	Poland		
CM	Cameroon	KR	Republic of Korea	PT	Portugal		
CN	China	KZ	Kazakhstan	RO	Romania		
CU	Cuba	LC	Saint Lucia	RU	Russian Federation		
CZ	Czech Republic	LI	Liechtenstein	SD	Sudan		
DE	Germany	LK	Sri Lanka	SE	Sweden		
DK	Denmark	LR	Liberia	SG	Singapore		
EE	Estonia						

GROUT OR MORTAR REMOVAL BY LASER

The present invention relates to the removal of grout or mortar particularly, though not exclusively from between tiles and bricks.

5

Tiles such as ceramic tiles are applied to the walls, floors and sometimes ceilings in hospitals, kitchens, bathrooms, biological and nuclear research laboratories and lavatories for example. Refractory tiles are used as
10 linings in furnaces, kilns and incinerators. Such tiled surfaces frequently have grout interposed between the tile edges so as to seal therebetween. One of the problems of a tiled surface is that contamination can enter into and exit through the porous grout between
15 adjoining tiles. The problem is exacerbated, as a result of the tile grout porosity, by water or chemical solutions, germs and other harmful agents often permeating into cavities behind the tiles and corroding the bonding agent used to fix the tiles to the substrate,
20 the substrate itself or even the tile since the backs of glazed tiles are frequently unglazed. Furthermore, the predominant problem with tile grout is that over a period of time it becomes contaminated, discoloured or may even disintegrate. Periodically, the grout has to be removed
25 physically which is an arduous, frequently ineffective and invariably costly undertaking.

Currently, the method used for the removal of grout comprises mechanical cutting using a saw blade or by
30 mechanical chiselling. In either case, the removal of grout cannot be made thoroughly. Furthermore, mechanical removal can often damage the tiles which make the process very expensive due to the need for tile replacement. Sometimes, damage to tiles can be relatively slight and

may consist only of chipping of the glazing. However, in this case the tile itself is frequently rendered porous resulting in the uptake of harmful substances. The work zone and the tools used to remove grout are frequently
5 contaminated. This is particularly undesirable when radioactive and/or biological contamination is present.

Similarly, during building work such as servicing, renovation, alterations and extensions in buildings and
10 civil installations, mortar between building blocks such as bricks, stone blocks, concrete tiles, stone tiles and metallic cladding tiles may need to be removed and replaced either completely or partially. The removal of mortar is currently carried out by using mechanical saw
15 blades, pneumatic chisels or manual chisels. During these operations, a great deal of noise is produced in addition to dust generation. The pollution to the environment caused by noise and dust is more severe when the operation is carried out inside a building. In these
20 circumstances, noise can be amplified and transmitted to many parts of a building remote from the site where work is being carried out thus causing discomfort to the people and affecting work normally carried out within the building. Furthermore, as in the case of grout between
25 tiles, mechanical means of removing mortar may sometimes cause damage to the edges of the building blocks which is especially deleterious in the case where the material is marble or granite and used for aesthetic purposes, and causes great fatigue and discomfort to the operatives
30 carrying out the work.

It is an object of the present invention to provide a non-contact method of removing tile grout which does not have the disadvantages of known mechanical methods.

According to the present invention there is provided a method for the removal of grout from between adjacent objects, the method comprising the steps of: directing
5 the beam of a laser device onto said grout at a power level to cause removal of the grout; causing mutual relative movement between said laser beam and said grout; and, providing removal means for debris resulting from said grout removal.

10

In the present specification, the term 'grout' should also be taken to include mortar or any other similar material used for example, to separate, join, delineate, fill-in between joints, joins or interfaces between
15 objects.

20

The objects may be ceramic and/or refractory tiles, building blocks such as bricks, stone blocks, cladding, marble tiles or slabs for example.

The laser device may be a portable unit capable of being moved to and from sites where grout removal is required.

Preferably the laser beam may have a wavelength in the
25 range from 0.4 μ m to 10.6 μ m. More preferably, the wavelength may be in the range from 0.4 μ m to 1.2 μ m. The laser beam spot size may be commensurate with the width of the grout filling or may be less than the width of grout filling.

30

The use of a non-contacting method of grout removal by laser results in grout removal which is both more efficient, does not cause damage to the tiles and minimises consequential contamination of the work zone.

Preferably, the laser beam is transmitted to the grout via optical fibre since such fibres are easily handled and manipulated. Nd-YAG and semi-conductor lasers are
5 examples of such lasers which may be employed with optical fibres. The use of a laser wavelength in the range from 0.4 μ m to 1.2 μ m has the dual advantage that a laser beam in this range of wavelengths may be transmitted via optical fibres and also that the laser
10 beam energy is relatively efficiently absorbed by the optically darker grout whereas it is reflected by the optically lighter glazed tiles so that the tiles are not damaged by the method.

15 Where optical fibres are used to transmit the laser beam to the grout, the laser beam may be collimated and focused or defocused after exiting the optical fibre to enable control of the spot size on the grout work surface.

20 A further type of laser which may be particularly suitable for carrying out the method of the present invention is a diode pumped fibre laser.

25 Focusing may be effected by a lens or curved mirror and the beam spot size may desirably be about $\frac{1}{4}$ of the width of the grout.

A pulsed laser beam having an energy of 1 to 10J/pulse, a
30 pulse width of 1 to 20ms and a beam spot size of 1 to 8mm for example may be used. The precise parameters will be governed inter alia by the grout width, volume and depth per unit length to be removed and, desired rate of removal and the grout material.

Alternatively, a continuous wave laser may be used, in which case, the average power should be more than 50W.

- 5 The physical and material characteristics of the grout to be removed will determine the power required but in general a power density in the range from 50W/cm² to 10MW/cm² may be employed depending upon the mode of operation.

10

Where laser beams having longer wavelengths are employed, delivery may be by a mirror system rather than optical fibre.

- 15 When a working laser having an infrared beam is used, e.g. Nd-YAG and GaAlAs diode lasers for example, a low power visible aiming laser beam such as from a HeNe laser or a visible semi-conductor laser having a low power of about 0.5mW to 3mW for example may be used coaxially with
20 the working laser which has a much higher power, so as to aid the positioning of the spot of the working laser beam. Such an arrangement is common in commercial high power lasers.

- 25 The laser beam may be aimed and operated manually or automatically. When automatic or semi-automatic processing is used, mechanical following, sensor/camera sensing of the location and path of the grout to guide the system positioning, and/or a robotics system may be
30 incorporated into the handling system.

Due to the reflective nature of glazed tiles or marble for example and the fact that such grout removal processing will often be carried out in a closed

environment, it is important that control of the laser beam is exercised at all times, especially where people are present within the environment. In order to prevent accidental escape of the laser beam due to reflection, a safety enclosure device which surrounds the limited area in which the laser beam is operating may be employed. The safety enclosure may comprise a box-like unit for example having an open face facing towards the surface where grout is to be removed, the face opposite to the open face is closed so as to prevent reflection by absorption, this face surrounding the laser processing optics. The enclosure may be made of optically transparent or partially transparent material which is opaque to the working laser beam wavelength and/or may be provided with an optically transparent window. The open end of the enclosure may be provided with switch means which only allow the laser beam to be used when the enclosure is adjacent the surface to be treated. Such switch means may comprise contact roller switches allowing the enclosure to be traversed across the surface to be treated with the laser. The material of the enclosure may allow a low power positioning laser as described hereinabove to be observed by an operator but will prevent transmission of the working laser beam wavelength. The enclosure may be provided with means to extract fume and debris resulting from grout removal therefrom. Such means may comprise suction extraction means and may include a suitable conduit within the enclosure having an extraction orifice adjacent the laser impingement working area to directly suck up resulting debris. The lower face of the enclosure may be provided with a sealing skirt in rubbing contact with the workpiece surface to prevent excessive egress of debris.

The laser may be provided with a nozzle coaxial to the laser beam so as to pass gas therethrough in order to prevent fouling of the laser optics by back-scattered debris and fumes. Such gases may include compressed air, nitrogen, argon and helium for example. The nozzle may additionally be utilised to provide a relatively high velocity and/or high pressure gas jet which impinges on the grout working spot to assist in debris removal. Alternatively, a separate gas jet nozzle may be provided in the enclosure and having an impingement point coincident with the laser working spot.

In our co-pending European patent application number 0 653 762, we describe a method of treating a concrete surface for example whereby the surface is treated with a high power laser under certain conditions to cause the surface layer of a hydraulically bonded material such as concrete to either spall off in small pieces or to become detached over a relatively large area due to the formation of a heat affected zone and resulting breaking of so-called hydraulic bonds and the dehydration caused. The dehydration is not merely the driving off of free water which might be in physical contact with the grout but the liberation of bound water of hydration in the material's chemical structure. In the present invention, most grouts tend to be either polymeric or hydraulically bonded materials. The grout on absorbing the laser beam energy raises its temperature. At relatively low temperatures organic compounds will start to decompose and water will vaporise very quickly causing internal pressure waves within the grout; the combination of these two effects together with high thermal stress gradients due to low thermal conductivity result in a rapid increase in internal stress and pressure within the grout

causing removal thereof. Laser heating is also non-uniform and causes local explosions or cracks resulting in the removal of the grout. Further additional stresses which assist grout removal may be caused by thermal
5 decomposition of inorganic components of the grout.

The rate of grout removal may be enhanced by wetting of the grout, prior to laser treatment, so that it absorbs water to increase the degree of steam formation and
10 internal stress in the grout.

When a continuous wave laser is used, the mechanism of grout removal is similar to that with a pulsed laser, however, more of the ejected material may be melted, with
15 some combustion of organic components.

A particular advantage of the method of the present invention is that due to the relatively high temperatures reached during the process, sterilisation of the
20 materials adjacent the grout area is achieved which may be important in the particular case where a wall facing comprises tiles in for example a hospital or laboratory. Where the grout is a mortar between building blocks the dust can be collected conveniently since the interaction
25 spot may be only around 2-8mm instead of 100-300mm for circular mechanical cutting blades or chisels for example. A further particular advantage is the reduction of noise and dust so as to produce significant environmental benefits. Furthermore, the process is a
30 non-contact process and no force is required to be applied by the operator. Thus, human fatigue is greatly reduced compared to mechanical mortar removal methods. The non-contact nature of the process also simplifies the requirements of manipulators or robot arms which are

employed in automated systems. Damage to building blocks and the substrate may also be minimised or avoided due to higher controllability of the process and much lower mechanical stresses imposed.

5

In our copending International patent application number WO95/22149, a method of forming a coating on a wall, for example, is described. The method comprises filling gaps between tiles with a vitrifiable grout material, heating
10 the grout with a laser beam for example, to cause vitrification and welding of the tiles together. The present invention may be used to remove old grout which is replaced and treated as in WO95/22149.

15 In order that the present invention may be more fully understood, examples will now be described by way of illustration only with reference to the accompanying drawings, of which:

20 Figure 1 shows a general schematic perspective view of a tiled area having grout between the tiles;

Figure 2 shows a schematic cross section through a laser head and enclosure employed in the method of the present
25 invention; and

Figure 3 which shows a schematic view of similar apparatus to that shown in Figure 2 for use in the method of the present invention.

30

Referring now to the drawings and where the same features are denoted by common reference numerals.

A small section 10 of four tiles 12 from a much larger area (not shown) is shown in Figure 1. Each tile 12 is separated by a gap filled with grout 14. A laser beam 16 is adjusted such that its spot 18 lies substantially wholly upon the grout 14. Figure 2 shows a schematic cross-section through an arrangement for carrying out the method of the present invention. The arrangement comprises the laser beam 16 from a laser device indicated at 17 impinging upon a focusing lens 20 (or a plurality of lenses) to form the desired laser beam spot 18 on the grout 14. The area of grout being treated is shrouded by an enclosure 22 having at least a face or window 23 made of optically transparent material but which is opaque to the particular laser wavelength in use. The enclosure 22 is provided with contact roller limit switches 24 allowing easy movement across the surface and such that the laser cannot be operated unless the switches 24 are in contact with the surface of the tiles 12. The enclosure 22 is sealingly but movably engaged with a shroud tube 26 having a nozzle 28 and a gas inlet 30. Gas which is non-reactive is pumped into the gas inlet 30 so as to exit from the nozzle 28 so as to prevent the focusing lens 20 from being contaminated by back scattered debris and fumes. The nozzle 28 also directs the gas flow onto the working area coincident with the laser beam spot 18 in order to assist removal of debris from the grout 14. Alternatively, a separate gas jet nozzle, indicated by the dashed lines 42, may be provided to cause a gas jet to impinge on the laser spot working area 18 to assist debris removal. However, the gas flow 30 to prevent contamination of the lens 20 will generally be maintained. The enclosure 22 is also provided with a gas extraction port 32 which is operably connected to a vacuum extraction system 44 to remove fume and debris

from a suction orifice 46 adjacent the working area. More than one suction tube, port and orifice may be provided. An open face 34 of the enclosure 22 is distanced from the tiled surface by the contact roller
5 limit switches 24 such that a net flow of air is drawn in through the open face of the enclosure and extracted via the port 32 and/or by another port 48, thereby, preventing egress of fume and contaminant to the environment. The enclosure 22 may be provided with a
10 flexible rubbing sealing skirt 49 to further minimise egress of debris. Although Figure 2 shows a laser beam 16 impinging upon the focusing lens 20, this may be replaced with an optical fibre as indicated with reference to Figure 3 below. The complete assembly 40 may be attached
15 to a manipulator such as a robotic arm indicated schematically by an attachment 36 to the enclosure 22 so as to move the assembly 40 in a predetermined manner so as to follow the lines of grout 14. The robotic arm 36 may be provided with suitable sensing means so as to
20 follow the lines of grout where these may be irregular or curved for example. Alternatively, the arrangement 40 may be moved manually by a suitably protected operator (not shown). The laser generator 17 itself may be mounted on a trolley (not shown).

25

Figure 3 shows a similar arrangement to Figure 2 but with a lens 20 holding arrangement 50 sealed into the shroud tube 26 and the lens 20, within the lens holding arrangement 50 and having a fibre optic 52 laser beam
30 supply from the remotely sited laser device 17. Manipulation of the assembly 40 is thus facilitated due to reduce mass and size.

In operation, the arrangements shown in Figures 2 and 3 may be used according to the following method. The laser device 17 is powered up and is aimed onto the grout 14 via a visible aiming laser such as a HeNe laser 60 which provides a coaxial beam 64 through a splitter 62, and the distance between the laser processing head comprising the focusing lens 20 and gas nozzle being adjusted so that a suitable beam spot size is obtained. The gas supply to the port 30 and the extraction system to the port 32 is switched on and, if operated manually, the operator may don suitable protective clothing, eye protection and breathing equipment as appropriate. The working laser may be operated by opening a laser shutter (not shown) through a hand held switch (when operated manually), the switch not being operable when the contact roller limit switches 24 are not in contact with the tile 12 surface. Depending upon the rate of grout removal at any one position, the beam/grout interaction point may be moved at an appropriate speed.

Since the laser beam has a well defined energy distribution and, the melting point of the tiles or building blocks are much higher than the temperature required to achieve disintegration of the grout, the use of a laser beam causes minimum damage to the tiles or building blocks contrary to prior art mechanical grout removal methods.

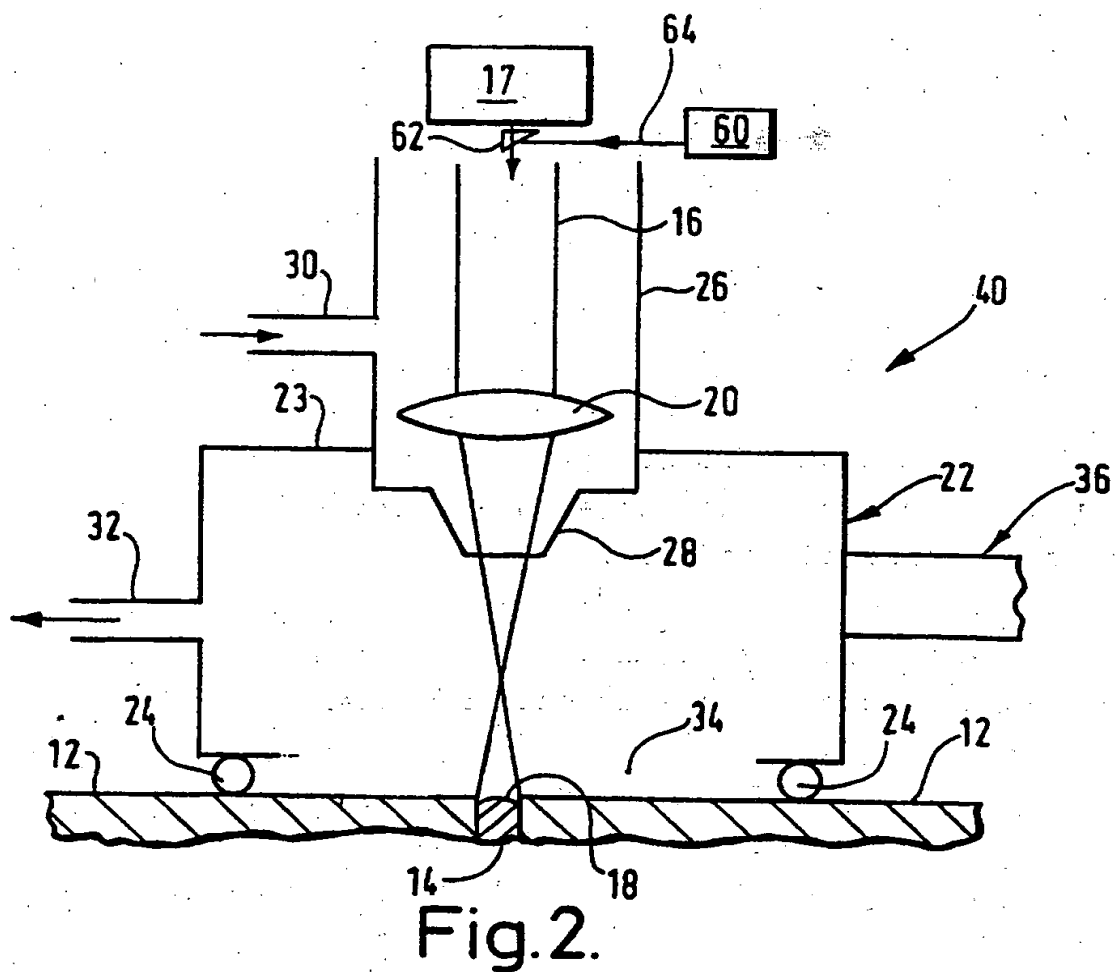
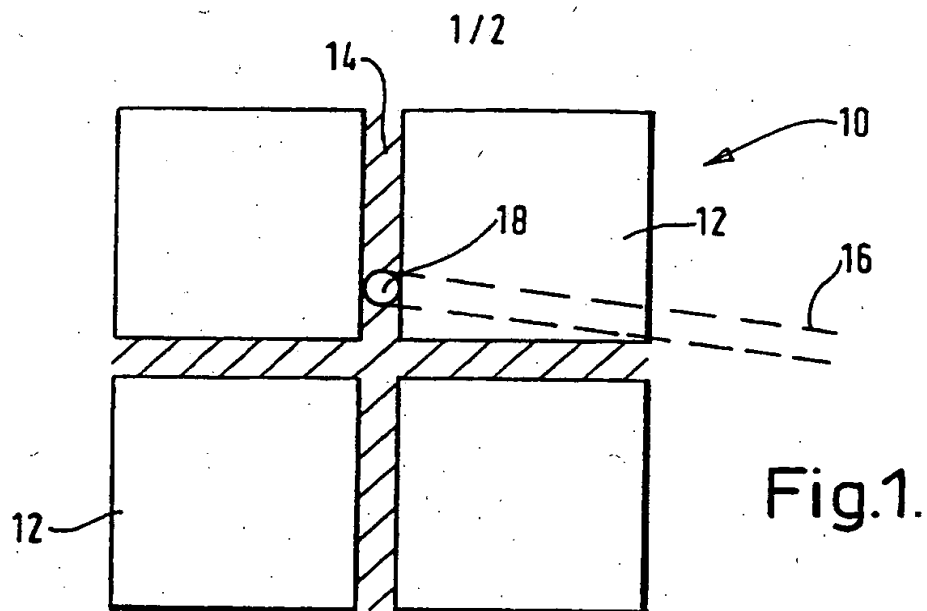
In the particular case of mortar which is generally employed between structural building blocks and which is generally a hydraulically bonded material; in Figure 1, the objects 12 may be considered to be structural building blocks such as bricks. At low power densities of less than about 150 W/cm^2 , the mortar material is

heated but not melted as thermal stress is generated within the mortar principally by dehydration of the bound water of hydration in the mortar structure causing cracks and disintegration. The loosened material can then be
5 extracted by use of suction and/or compressed air for example, the compressed air being used to aid removal of any partially detached particles. At medium power densities of about $150-800 \text{ W/cm}^2$, the moisture within the mortar during thermal dehydration of the bound water of
10 hydration expands in an explosive manner causing detachment of mortar pieces rather than in dust form from the surface. Very little heat damage such as melting is generated in this mode. At higher power densities up to about 10000 W/cm^2 the mortar will melt and vaporise and a
15 heat effected zone is often generated below the melted surface. At very high power densities greater than 10000 W/cm^2 and which is often operated in the pulsed laser mode, the beam to material interaction time is very short and thus the thermal penetration depth which is
20 (proportional to the square root of the interaction time) is small. A small part of the surface is vaporised and a shock wave is produced which causes fracture of the underlying material thus enabling the removal of the mortar simply by fracture and subsequent extraction.
25 Very little heat effected zone is produced in this mode.

CLAIMS

1. A method for the removal of grout as hereinbefore defined from between adjacent objects, the method comprising the steps of: directing the beam of a laser device onto said grout at a power level to cause removal of the grout; causing mutual relative movement between said laser beam and said grout; and, providing removal means for debris resulting from said grout removal.
2. A method according to claim 1 wherein the laser device is a portable unit capable of being moved to and from sites where grout removal is required.
3. A method according to either claim 1 or claim 2 wherein the laser beam is transmitted to the grout via optical fibre.
4. A method according to any one preceding claim wherein the laser is selected from the group comprising: Nd-YAG laser; semi-conductor laser; and, diode pumped fibre laser.
5. A method according to any one preceding claim wherein the laser also includes a low-power visible aiming laser.
6. A method according to any one preceding claim wherein an area of grout being treated is surrounded by an enclosure to prevent escape of laser light.
7. A method according to claim 6 wherein the enclosure is transparent to optical light and opaque to laser light of the wavelength in use.

8. A method according to any one preceding claim wherein the laser beam has a wavelength of 0.4 to 10.6 μ m.
- 5 9. A method according to claim 8 wherein the laser beam has a wavelength of from 0.4 to 1.2 μ m.
- 10 10. A method according to any one preceding claim wherein the laser beam spot size is commensurate with the grout width.
- 15 11. A method according to any one preceding claim wherein said debris removal means comprises suction removal at a position adjacent the grout laser treatment area.
- 20 12. A method according to any one preceding claim further including the step of assisting debris removal with a gas jet.
13. A method according to any one preceding claim from 6 to 12 further including the step of providing an optically translucent area in said enclosure.
- 25 14. A method according to any one preceding claim wherein the adjacent objects are tiles or building blocks as hereinbefore defined.
- 30 15. A method according to any one preceding claim wherein the grout has additional water applied.



INTERNATIONAL SEARCH REPORT

Intern al Application No
PCT/GB 97/01638

A. CLASSIFICATION OF SUBJECT MATTER
IPC 6 B28D1/22 B23K26/00 E04F21/16

According to International Patent Classification (IPC) or to both national classification and IPC

B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)

IPC 6 B28D E04F B23K

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the international search (name of data base and, where practical, search terms used)

C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
A	EP 0 552 751 A (MASCHINENBAU HUBERT HAMACHER) 28 July 1993 see abstract; figure 1	1,14
A	WO 95 35575 A (BRITISH NUCLEAR FUELS PLC) 28 December 1995 see the whole document	1-13
A	WO 95 27986 A (BRITISH NUCLEAR FUELS PLC) 19 October 1995 see page 5, line 17 - line 22 see page 7, line 18 - line 22 see page 8, line 25 - page 13, line 23; figures	1

☒ Further documents are listed in the continuation of box C.

☒ Patent family members are listed in annex.

* Special categories of cited documents:

- *A* document defining the general state of the art which is not considered to be of particular relevance
- *E* earlier document but published on or after the international filing date
- *L* document which may throw doubts on priority claim(s) or which is cited to establish the publication date of another citation or other special reason (as specified)
- *O* document referring to an oral disclosure, use, exhibition or other means
- *P* document published prior to the international filing date but later than the priority date claimed

- *T* later document published after the international filing date or priority date and not in conflict with the application but cited to understand the principle or theory underlying the invention
- *X* document of particular relevance; the claimed invention cannot be considered novel or cannot be considered to involve an inventive step when the document is taken alone
- *Y* document of particular relevance; the claimed invention cannot be considered to involve an inventive step when the document is combined with one or more other such documents, such combination being obvious to a person skilled in the art.
- *A* document member of the same patent family

Date of the actual completion of the international search

10 September 1997

Date of mailing of the international search report

25.09.1997

Name and mailing address of the ISA

European Patent Office, P.B. 5818 Patentlaan 2
NL - 2280 HV Rijswijk
Tel. (+ 31-70) 340-2040, Tx. 31 651 epo nl,
Fax: (+ 31-70) 340-3016

Authorized officer

Moet, H

INTERNATIONAL SEARCH REPORT

Intern al Application No

PCT/GB 97/01638

C (Continuation) DOCUMENTS CONSIDERED TO BE RELEVANT

Category	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
A	WO 94 19140 A (ELECTRIC POWER RESEARCH INSTITUTE INC) 1 September 1994 see abstract see page 8, line 20 - line 22 ----	1,9
A	EP 0 642 846 A (ONET SA) 15 March 1995 ----	
A	GB 2 261 901 A (M.J.R. YOUNG) 2 June 1993 -----	

INTERNATIONAL SEARCH REPORT

Information on patent family members

Intern. al Application No

PCT/GB 97/01638

Patent document cited in search report	Publication date	Patent family member(s)	Publication date
EP 552751 A	28-07-93	NONE	
WO 9535575 A	28-12-95	CA 2193200 A EP 0765523 A	28-12-95 02-04-97
WO 9527986 A	19-10-95	EP 0755560 A	29-01-97
WO 9419140 A	01-09-94	US 5356081 A AU 680868 B AU 6025894 A CA 2153985 A EP 0730507 A ZA 9400542 A	18-10-94 14-08-97 14-09-94 01-09-94 11-09-96 09-09-94
EP 642846 A	15-03-95	FR 2708877 A	17-02-95
GB 2261901 A	02-06-93	NONE	